



QL24N50

500V N-Channel MOSFET

General Description

The 24N50 is fabricated using an advanced high voltage MOSFET process that is designed to provide excellent $R_{DS(ON)}$. These devices are well suited for high efficient switched mode power supplies and active power factor correction.

Features

- Low on-resistance
- Fast Switching
- RoHS Compliant

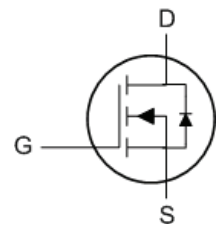
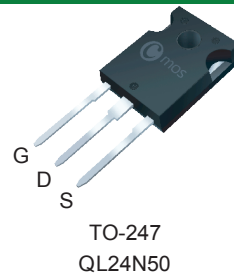
Product Summary

BVDSS	RDSON	ID
500V	0.2Ω	24A

Applications

- DC-AC converters
- SMPS Power
- UPS (Uninterruptible Power Supply)

TO247 Pin Configuration



Absolute Maximum Ratings

Symbol	Parameter	Rating	Units
V_{DS}	Drain-Source Voltage	500	V
V_{GS}	Gate-Source Voltage	±30	V
$I_D@T_C=25^{\circ}C$	Continuous Drain Current	24	A
$I_D@T_C=100^{\circ}C$	Continuous Drain Current	15	A
I_{DM}	Pulsed Drain Current ¹	96	A
EAS	Single Pulse Avalanche Energy ²	810	mJ
$P_D@T_C=25^{\circ}C$	Total Power Dissipation	290	W
T_{STG}	Storage Temperature Range	-55 to 150	°C
T_J	Operating Junction Temperature Range	-55 to 150	°C

Thermal Data

Symbol	Parameter	Typ.	Max.	Unit
$R_{\theta JA}$	Thermal Resistance Junction-ambient	---	40	°C/W
$R_{\theta JC}$	Thermal Resistance Junction-case	---	0.43	°C/W



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Electrical Characteristics ($T_J=25^{\circ}\text{C}$, unless otherwise noted)

Symbol	Parameter	Conditions	Min.	Typ.	Max.	Unit
BV_{DSS}	Drain-Source Breakdown Voltage	$V_{GS}=0V$, $I_D=250\mu A$	500	---	---	V
$R_{DS(ON)}$	Static Drain-Source On-Resistance	$V_{GS}=10V$, $I_D=12A$	---	---	0.2	Ω
$V_{GS(th)}$	Gate Threshold Voltage	$V_{GS}=V_{DS}$, $I_D=250\mu A$	2	---	4	V
I_{DSS}	Drain-Source Leakage Current	$V_{DS}=500V$, $V_{GS}=0V$	---	---	1	μA
		$V_{DS}=400V$, $V_{GS}=0V$, $TC=125^{\circ}\text{C}$	---	---	10	
I_{GSS}	Gate-Source Leakage Current	$V_{GS}=\pm 30V$, $V_{DS}=0V$	---	---	± 100	nA
g_{fs}	Forward Transconductance ³	$V_{DS}=15V$, $I_D=13A$	---	31	---	S
Q_g	Total Gate Charge	$I_D=24A$	---	90	---	nC
Q_{gs}	Gate-Source Charge	$V_{DS}=400V$	---	22	---	
Q_{gd}	Gate-Drain Charge	$V_{GS}=10V$ (Note 3, 4)	---	45	---	
$T_{d(on)}$	Turn-On Delay Time	$V_{DD}=250V$	---	100	---	ns
T_r	Rise Time	$I_D=24A$	---	250	---	
$T_{d(off)}$	Turn-Off Delay Time	$R_G=25\Omega$	---	200	---	
T_f	Fall Time	(Note 3, 4)	---	150	---	
C_{iss}	Input Capacitance	$V_{DS}=25V$, $V_{GS}=0V$, $f=1\text{MHz}$	---	6300	---	pF
C_{oss}	Output Capacitance		---	600	---	
C_{rss}	Reverse Transfer Capacitance		---	65	---	

Diode Characteristics

Symbol	Parameter	Conditions	Min.	Typ.	Max.	Unit
I_S	Continuous Source Current	$V_G=V_D=0V$, Force Current	---	---	24	A
I_{SM}	Pulsed Source Current		---	---	72	A
V_{SD}	Diode Forward Voltage	$V_{GS}=0V$, $I_S=24A$, $T_J=25^{\circ}\text{C}$	---	---	1.4	V

Note :

- 1.Repetitive Rating: Pulse width limited by maximum junction temperature
- 2.L = 5mH, $I_D=18A$, $V_{DD}=50V$, Starting $T_J=25^{\circ}\text{C}$
- 3.Pulse Test: Pulse width $\leq 300\mu s$, Duty Cycle $\leq 2\%$
- 4.Essentially Independent of Operating Temperature

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